



#### DUAL N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI®

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
	20mΩ @ V <sub>GS</sub> = 10V	6.8A
00) <i>(</i>	22mΩ @ V <sub>GS</sub> = 4.5V	6.5A
20V	26mΩ @ V <sub>GS</sub> = 2.5V	6.1A
	36mΩ @ V <sub>GS</sub> = 1.8V	5.2A

#### Description

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(on)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### Applications

- Power management functions
- Load Switch

#### Features

- Low On-Resistance
- Low Input Capacitance
- ESD Protected Up To 2kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

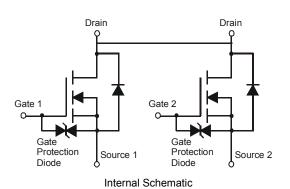
# Mechanical Data

- Case: POWERDI3030-8
- Case Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Weight: 0.0072 grams (approximate)





POWERDI3030-8



#### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2028UFDH-7	POWERDI3030-8	3,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

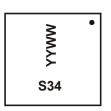
See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimopy compounds.</li>

<1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**

Notes:



S34 = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 13 = 2013) WW = Week Code (01 to 53)



### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V <sub>DSS</sub>	20	V		
Gate-Source Voltage (Note 5)	V <sub>GSS</sub>	±12	V		
Continuous Drain Current (Note 7) \/ = 40\/	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	Ι <sub>D</sub>	6.8 5.8	А
Continuous Drain Current (Note 7) V <sub>GS</sub> = 10V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	Ι <sub>D</sub>	8.8 7.0	А
Maximum Body Diode Forward Current (Note 7)	ls	2	A		
Pulsed Drain Current (10µs pulse, Duty cycle = 1%)			I <sub>DM</sub>	40	A

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 6)		PD	1.1	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	D	118	°C/W
Thermal Resistance, Junction to Ambient (Note 0)	t<10s	$R_{ heta}JA$	72	
Total Power Dissipation (Note 7)		PD	1.5	W
Thermal Desistance Junction to Ambient (Note 7)	Steady state	D	82	°C/W
Thermal Resistance, Junction to Ambient (Note 7)	t<10s	$R_{ heta JA}$	50	
Thermal Resistance, Junction to Case (Note 7)		$R_{\theta JC}$	14	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

### **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_	_	V	$V_{GS}$ = 0V, I <sub>D</sub> = 250µA	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>			1	μA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_		±10	μA	$V_{GS} = \pm 10V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.5	—	1	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
			16	20		V <sub>GS</sub> = 10V, I <sub>D</sub> = 4A	
Static Drain-Source On-Resistance	D		17	22	mΩ	$V_{GS}$ = 4.5V, $I_{D}$ = 4A	
	R <sub>DS</sub> (ON)	_	19	26		$V_{GS}$ = 2.5V, $I_{D}$ = 4A	
			24	36		V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 4A	
Forward Transfer Admittance	Y <sub>fs</sub>	—	8	_	S	V <sub>DS</sub> = 5V, I <sub>D</sub> = 12A	
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1.0	V	$V_{GS} = 0V, I_{S} = 5A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	_	151	—	pF	14 4014 M 014	
Output Capacitance	Coss	—	91	—	pF	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	—	32		pF	1 - 1.00112	
Gate Resistance	Rg	_	200	_	Ω	$V_{DS}$ = 0V, $V_{GS}$ = 0V, f = 1MHz	
Total Gate Charge	Qg	_	8.5	_	nC	V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 10V, I <sub>D</sub> = 6.5A	
Gate-Source Charge	Q <sub>gs</sub>	_	1.6	_	nC		
Gate-Drain Charge	Q <sub>gd</sub>	_	2.8	_	nC		
Turn-On Delay Time	t <sub>D(on)</sub>		53		ns	 V <sub>GS</sub> = 10V, V <sub>DS</sub> = 4.5V,	
Turn-On Rise Time	tr		77	_	ns		
Turn-Off Delay Time	t <sub>D(off)</sub>		561		ns	$R_G = 6\Omega, R_L = 1.0 \Omega, I_D = 1A$	
Turn-Off Fall Time	t <sub>f</sub>	_	234		ns	7	

Notes: 5. AEC-Q101  $V_{GS}$  maximum is ±9.6V.

7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

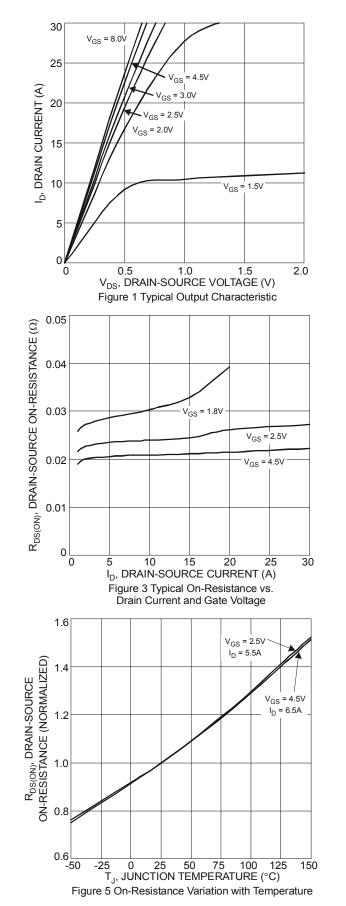
8 .Short duration pulse test used to minimize self-heating effect.

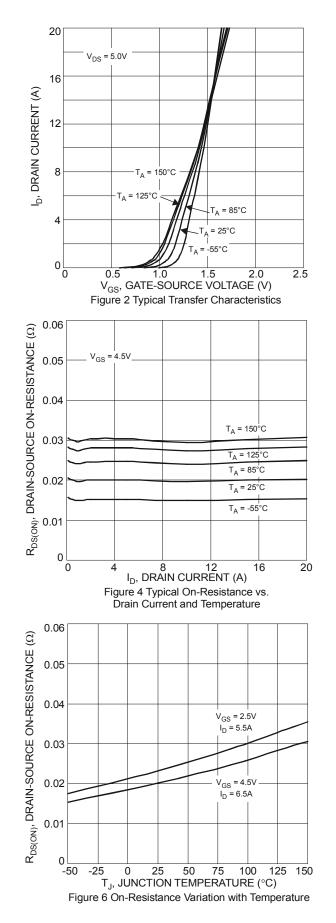
9. Guaranteed by design. Not subject to production testing.

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<sup>6.</sup> Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.



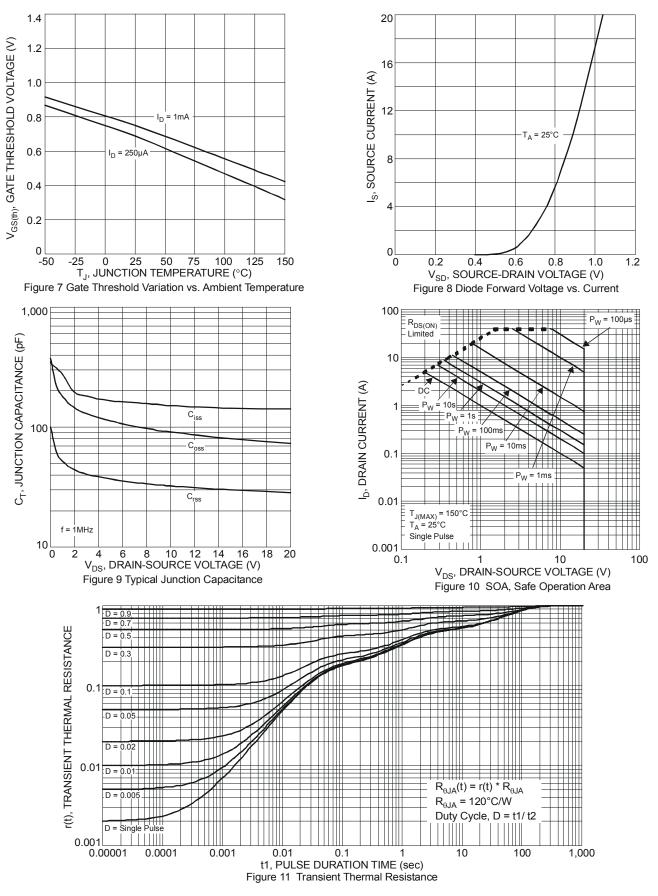




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### DMN2028UFDH

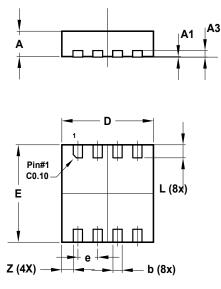






## **Package Outline Dimensions**

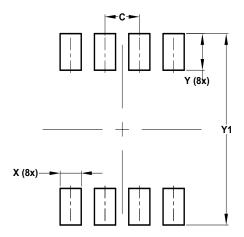
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



POWERDI3030-8					
Dim	Min Max Ty				
Α	0.75	0.85	0.80		
A1	0	0.05	0.02		
A3	-	-	0.203		
b	0.25	0.35	0.30		
D	2.95	3.05	3.00		
E	2.95	3.05	3.00		
е	-	-	0.65		
L	0.55	0.65	0.60		
Z	-	-	0.375		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	0.650		
Х	0.400		
Y	0.850		
Y1	3.400		



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